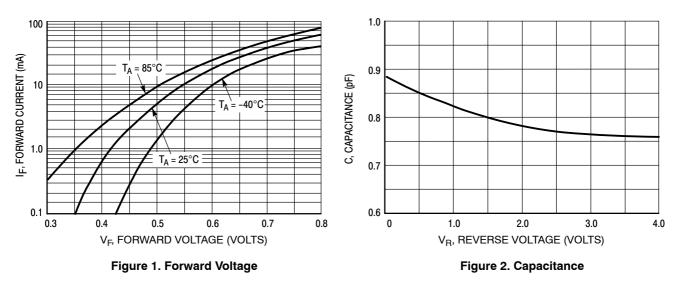
MMBD352LT1, MMBD353LT1, MMBD354LT1, MMBD355LT1



TYPICAL CHARACTERISTICS

ORDERING INFORMATION

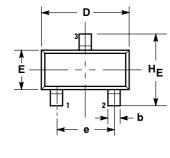
Device	Marking	Package	Shipping [†]
MMBD352LT1	M5G	SOT-23	3,000 Units / Tape & Reel
MMBD352LT1G		SOT-23 (Pb-Free)	3,000 Units / Tape & Reel
MMBD352LT3		SOT-23	10,000 Units / Tape & Reel
MMBD352LT3G		SOT-23 (Pb-Free)	10,000 Units / Tape & Reel
MMBD353LT1	M4F	SOT-23	3,000 Units / Tape & Reel
MMBD353LT1G		SOT-23 (Pb-Free)	3,000 Units / Tape & Reel
MMBD353LT3		SOT-23	10,000 Units / Tape & Reel
MMBD353LT3G		SOT-23 (Pb-Free)	10,000 Units / Tape & Reel
MMBD354LT1		SOT-23	3,000 Units / Tape & Reel
MMBD354LT1G	M6H	SOT-23 (Pb-Free)	3,000 Units / Tape & Reel
MMBD355LT1		SOT-23	3,000 Units / Tape & Reel
MMBD355LT1G	MJ1	SOT-23 (Pb-Free)	3,000 Units / Tape & Reel

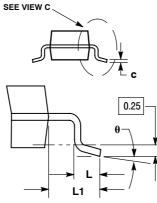
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MMBD352LT1, MMBD353LT1, MMBD354LT1, MMBD355LT1

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AN





VIEW C

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD

THICKNESS IS THE MINIMUM THICKNESS OF

BASE MATERIAL.

4. 318-01 THRU -07 AND -09 OBSOLETE NEW STANDARD 318-08.

INCHES	MILLIMETERS			
MIN NOM M	MAX	NOM	MIN	DIM
0.035 0.040 0	1.11	1.00	0.89	Α
0.001 0.002 0	0.10	0.06	0.01	A1
0.015 0.018 0	0.50	0.44	0.37	b
0.003 0.005 0	0.18	0.13	0.09	С
0.110 0.114 0	3.04	2.90	2.80	D
0.047 0.051 0	1.40	1.30	1.20	E
0.070 0.075 0	2.04	1.90	1.78	е
0.004 0.008 0	0.30	0.20	0.10	L
0.014 0.021 0	0.69	0.54	0.35	L1
0.083 0.094 0	2.64	2.40	2.10	HE
0.047 0.051 0.070 0.075 0.004 0.008 0.014 0.021	1.40 2.04 0.30 0.69	1.30 1.90 0.20 0.54	1.20 1.78 0.10 0.35	E e L L1

MMBD352LT1

STYLE 11:

PIN 1. ANODE 2. CATHODE

3. CATHODE 3. CATHODE-ANODE

MMBD353LT1

STYLE 19:

- PIN 1. CATHODE 2. ANODE
- 3. CATHODE-ANODE

MMBD354LT1

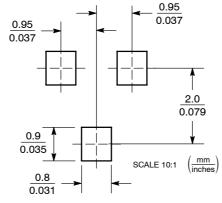
STYLE 9: PIN 1. ANODE

2. ANODE 3. CATHODE

MMBD355LT1

STYLE 12: PIN 1. CATHODE 2. CATHODE 3. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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